

**REGULATORY COMPLIANCE**

 <b>Lead Free</b> COMPLIANT	 <b>EU RoHS</b> 2011/65 + 2015/863 COMPLIANT	 <b>China RoHS</b> COMPLIANT	 <b>REACH</b> <b>SVHC</b> COMPLIANT	 <b>DRC</b> <b>CONFLICT</b> <b>FREE</b>
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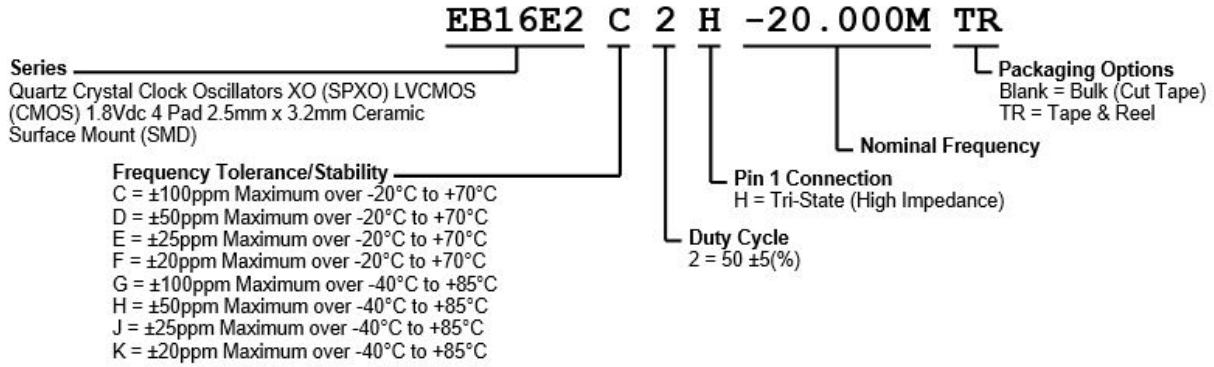
**ITEM DESCRIPTION**

Quartz Crystal Clock Oscillators XO (SPXO) LVCMOS (CMOS) 1.8Vdc 4 Pad 2.5mm x 3.2mm Ceramic Surface Mount (SMD)

**ELECTRICAL SPECIFICATIONS**

<b>Nominal Frequency</b>	1.024MHz to 66.6666MHz
<b>Frequency Tolerance/Stability</b>	Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, First Year Aging at 25°C, Shock, and Vibration ±100ppm Maximum over -20°C to +70°C ±50ppm Maximum over -20°C to +70°C ±25ppm Maximum over -20°C to +70°C ±20ppm Maximum over -20°C to +70°C ±100ppm Maximum over -40°C to +85°C ±50ppm Maximum over -40°C to +85°C ±25ppm Maximum over -40°C to +85°C ±20ppm Maximum over -40°C to +85°C
<b>Supply Voltage</b>	1.8Vdc ±5%
<b>Input Current</b>	3mA Maximum over Nominal Frequency of 1.024MHz to 9.999999MHz 4mA Maximum over Nominal Frequency of 10MHz to 39.999999MHz 5mA Maximum over Nominal Frequency of 40MHz to 50MHz 6mA Maximum over Nominal Frequency of 50.000001MHz to 66.6666MHz
<b>Output Voltage Logic High (V<sub>OH</sub>)</b>	I <sub>OH</sub> = -4mA 90% of V <sub>DD</sub> Minimum
<b>Output Voltage Logic Low (V<sub>OL</sub>)</b>	I <sub>OL</sub> = +4mA 10% of V <sub>DD</sub> Maximum
<b>Rise/Fall Time</b>	Measured at 20% to 80% of waveform 5nSec Maximum over Nominal Frequency of 1.024MHz to 24MHz 4nSec Maximum over Nominal Frequency of 24.000001MHz to 50MHz 3nSec Maximum over Nominal Frequency of 50.000001MHz to 66.6666MHz
<b>Duty Cycle</b>	Measured at 50% of Waveform 50 ±5(%)
<b>Load Drive Capability</b>	15pF Maximum
<b>Output Logic Type</b>	CMOS
<b>Logic Control / Additional Output</b>	Tri-State (High Impedance)
<b>Tri-State Input Voltage (V<sub>IH</sub> and V<sub>IL</sub>)</b>	80% of V <sub>DD</sub> Minimum or No Connect to Enable Output, 20% of V <sub>DD</sub> Maximum to Disable Output (High Impedance)
<b>Standby Current</b>	Disabled Output: High Impedance 10µA Maximum
<b>RMS Phase Jitter</b>	F <sub>j</sub> = 12kHz to 20MHz 1pSec Maximum
<b>Start Up Time</b>	10mSec Maximum
<b>Storage Temperature Range</b>	-55°C to +125°C

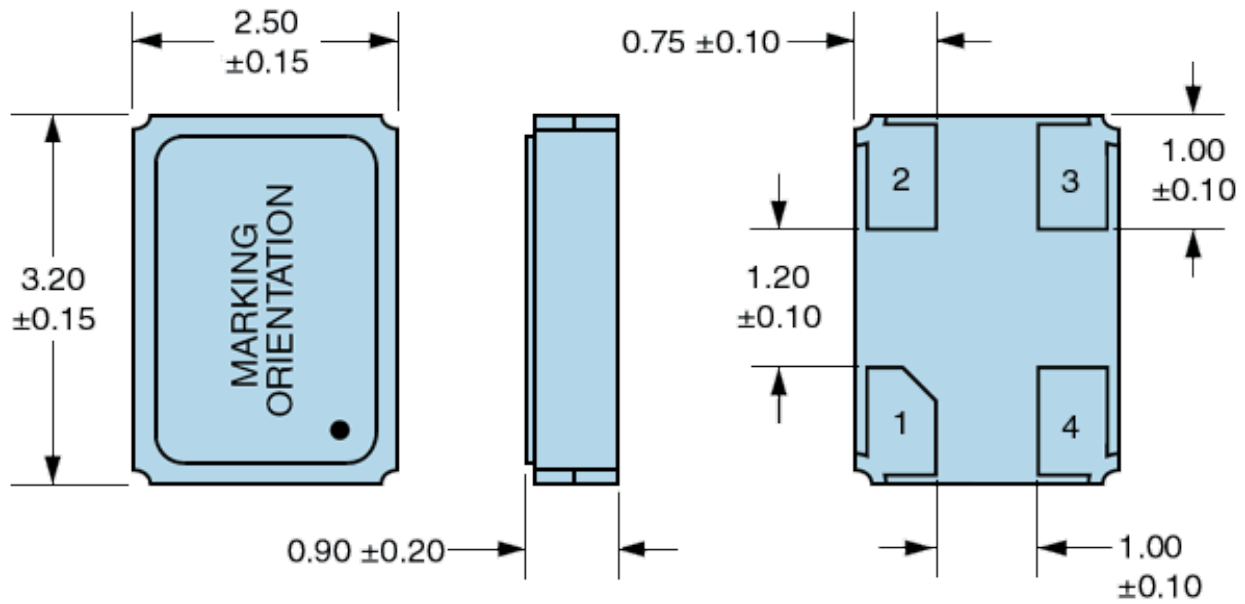
**PART NUMBERING GUIDE**



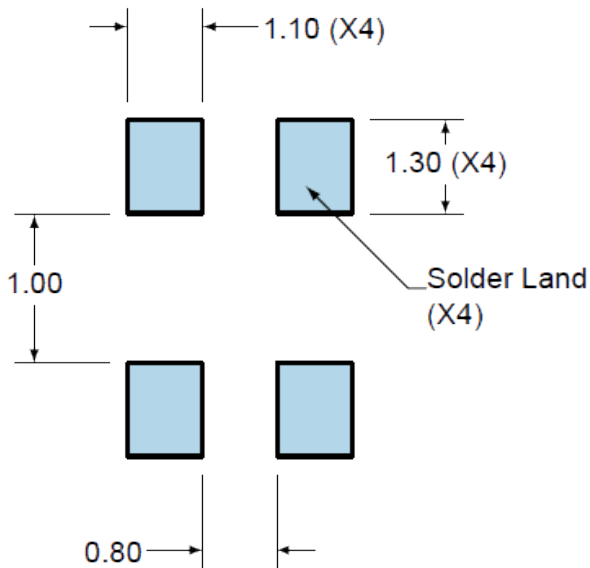
**ENVIRONMENTAL & MECHANICAL SPECIFICATIONS**

<b>ESD Susceptibility</b>	MIL-STD-883, Method 3015, Class 1, HBM: 1500V
<b>Fine Leak Test</b>	MIL-STD-883, Method 1014, Condition A
<b>Flammability</b>	UL94-V0
<b>Gross Leak Test</b>	MIL-STD-883, Method 1014, Condition C
<b>Mechanical Shock</b>	MIL-STD-883, Method 2002, Condition B
<b>Moisture Resistance</b>	MIL-STD-883, Method 1004
<b>Moisture Sensitivity</b>	J-STD-020, MSL 1
<b>Resistance to Soldering Heat</b>	MIL-STD-202, Method 210, Condition K
<b>Resistance to Solvents</b>	MIL-STD-202, Method 215
<b>Solderability</b>	MIL-STD-883, Method 2003
<b>Temperature Cycling</b>	MIL-STD-883, Method 1010, Condition B
<b>Vibration</b>	MIL-STD-883, Method 2007, Condition A

**MECHANICAL DIMENSIONS**



**SUGGESTED SOLDER PAD LAYOUT**

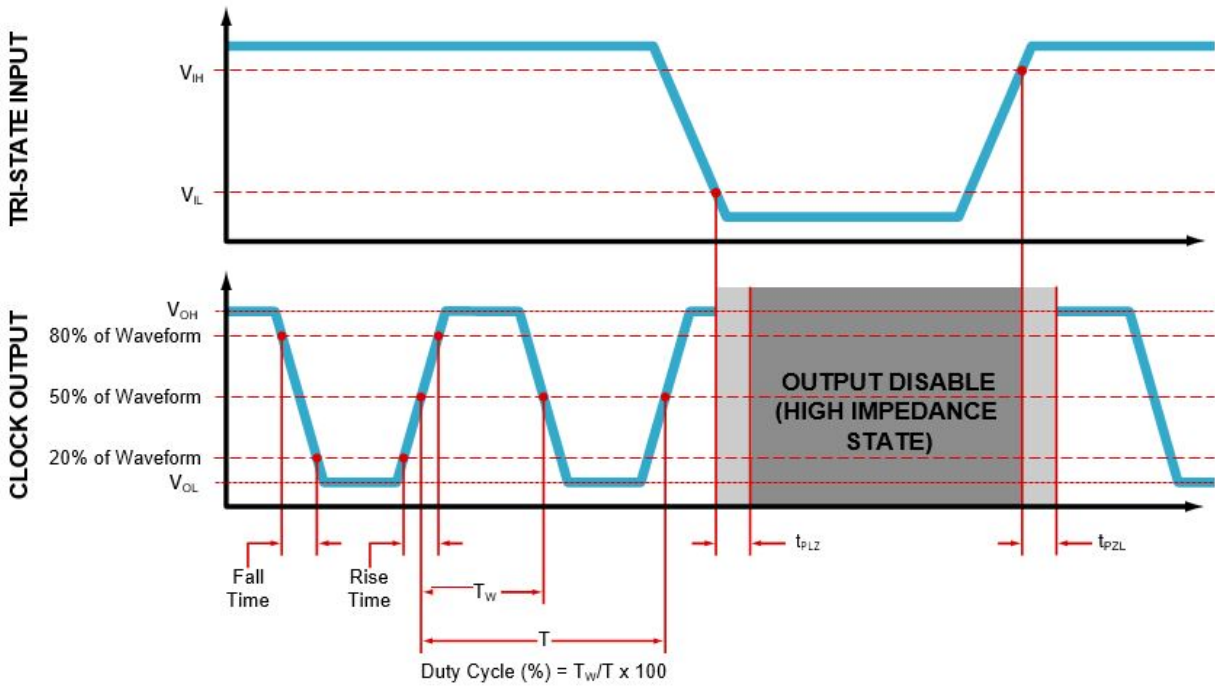


PIN	CONNECTION
1	Tri-State
2	Case/Ground
3	Output
4	Supply Voltage

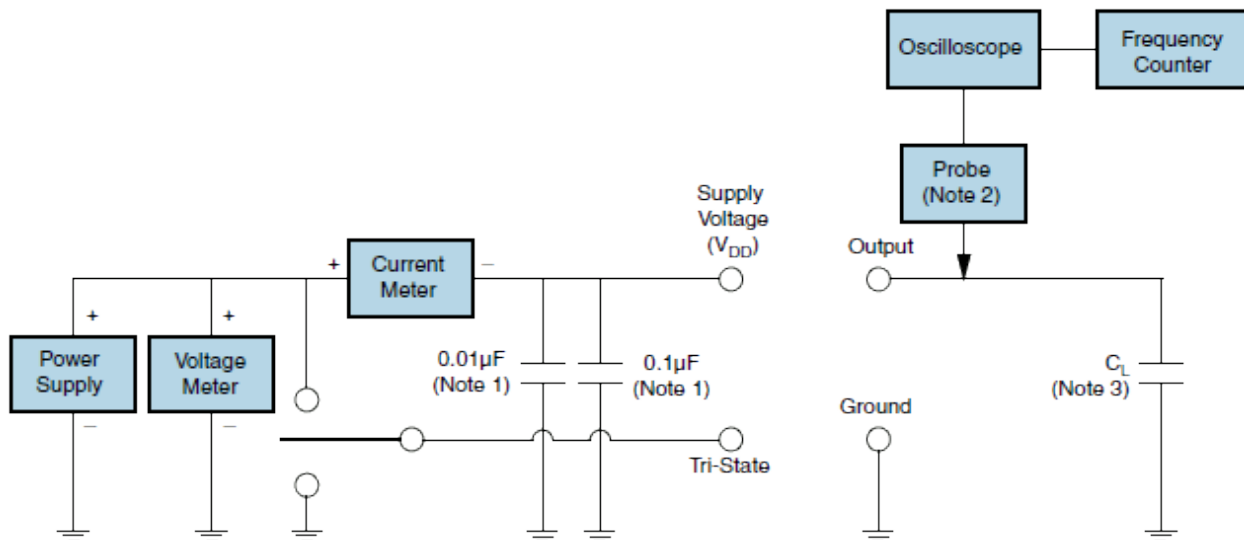
All Tolerances are  $\pm 0.1$

**All Dimensions in Millimeters**

OUTPUT WAVEFORM & TIMING DIAGRAM



## TEST CIRCUIT FOR CMOS OUTPUT



**Note 1:** An external  $0.1\mu\text{F}$  low frequency tantalum bypass capacitor in parallel with a  $0.01\mu\text{F}$  high frequency ceramic bypass Capacitor close to the package ground and  $V_{DD}$  pin is required.

**Note 2:** A low input capacitance ( $<12\text{pF}$ ), 10X Attenuation Factor, High Impedance ( $>10\text{Mohms}$ ), and High bandwidth ( $>300\text{MHz}$ ) Passive probe is recommended.

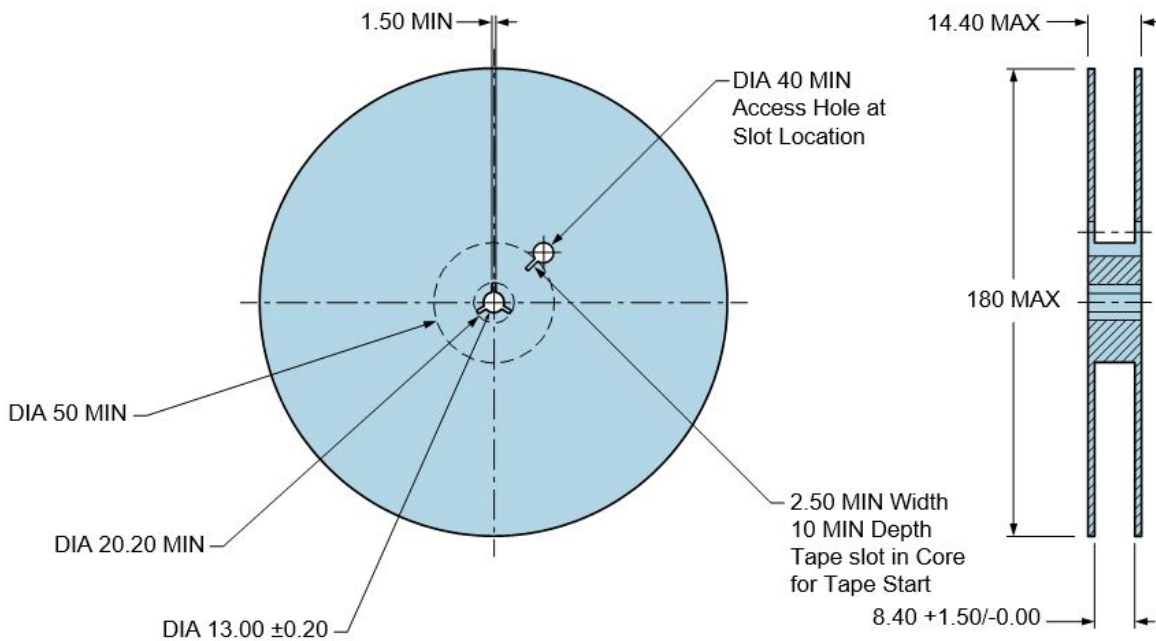
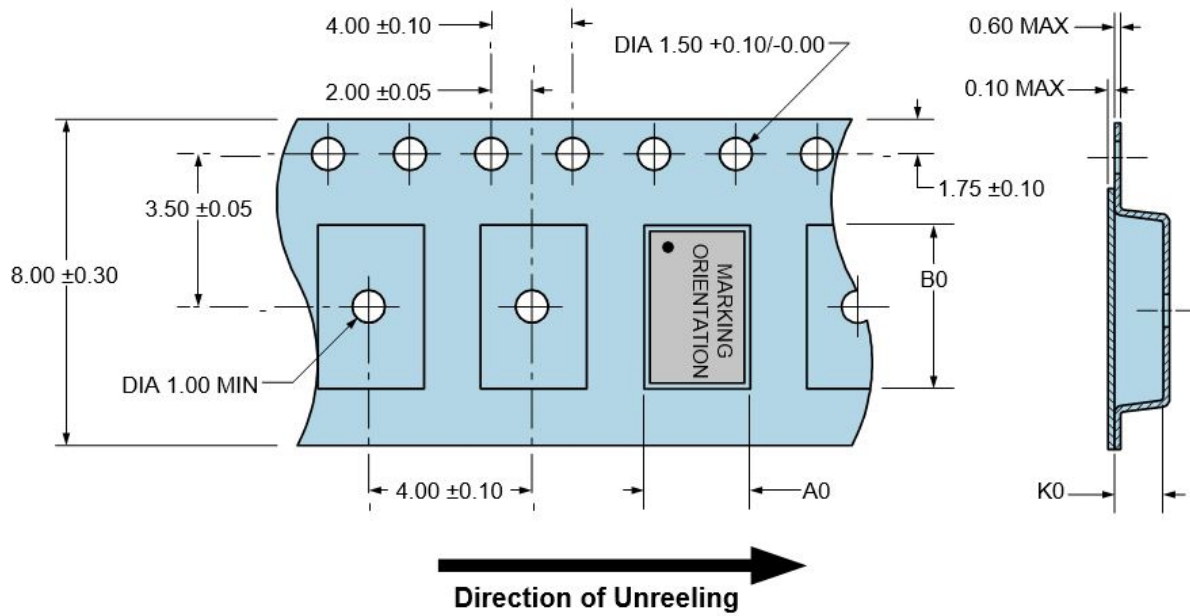
**Note 3:** Capacitance value  $C_L$  includes sum of all probe and fixture capacitance. See applicable specification sheet for 'Load Drive Capability'.

**TAPE & REEL DIMENSIONS**

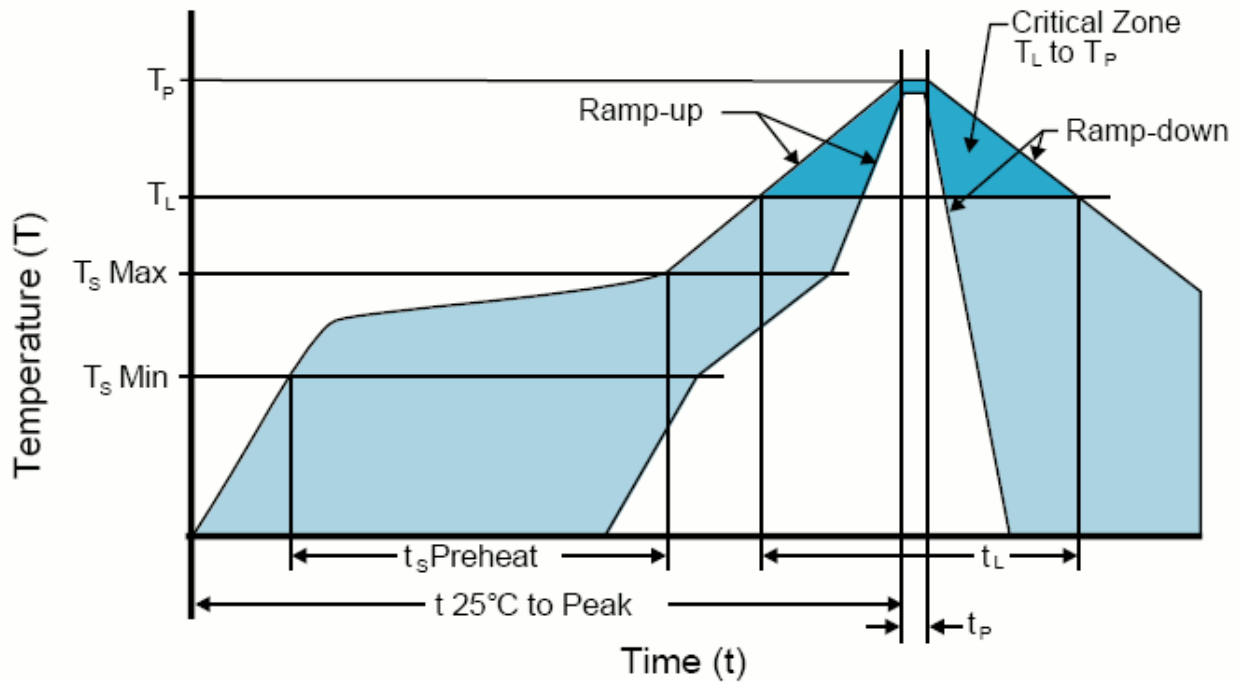
Quantity per Reel: 1000 Units

All Dimensions in Millimeters

Compliant to EIA-481



RECOMMENDED SOLDER REFLOW METHOD



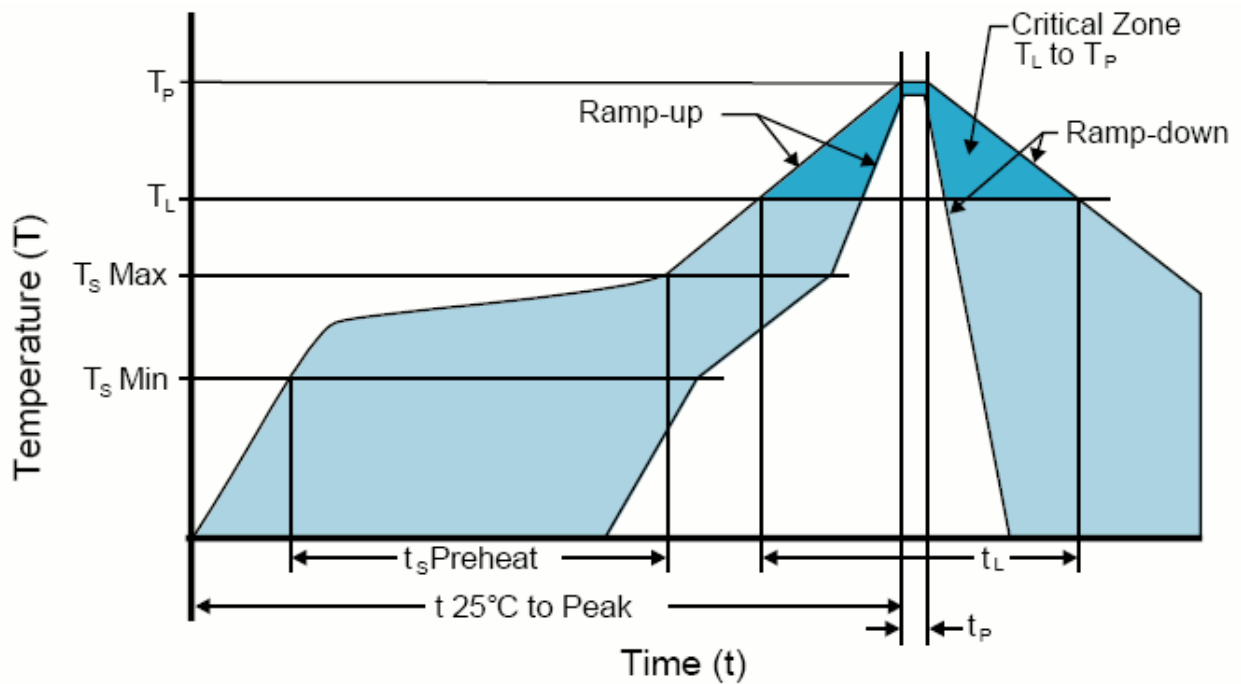
**HIGH TEMPERATURE INFRARED/CONVECTION**

T <sub>S</sub> MAX to T <sub>L</sub> (Ramp-up Rate)	3°C/Second Maximum
<b>Preheat</b>	
- Temperature Minimum (T <sub>S</sub> MIN)	150°C
- Temperature Typical (T <sub>S</sub> TYP)	175°C
- Temperature Maximum(T <sub>S</sub> MAX)	200°C
- Time (t <sub>s</sub> )	60 - 180 Seconds
<b>Ramp-up Rate (T<sub>L</sub> to T<sub>P</sub>)</b>	3°C/Second Maximum
<b>Time Maintained Above:</b>	
- Temperature (T <sub>L</sub> )	217°C
- Time (t <sub>L</sub> )	60 - 150 Seconds
<b>Peak Temperature (T<sub>P</sub>)</b>	260°C Maximum for 10 Seconds Maximum
<b>Target Peak Temperature(T<sub>P</sub> Target)</b>	250°C +0/-5°C
<b>Time within 5°C of actual peak (t<sub>p</sub>)</b>	20 - 40 Seconds
<b>Ramp-down Rate</b>	6°C/Second Maximum
<b>Time 25°C to Peak Temperature (t)</b>	8 Minutes Maximum
<b>Moisture Sensitivity Level</b>	Level 1
<b>Additional Notes</b>	Temperatures shown are applied to body of device.

**High Temperature Manual Soldering**

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

RECOMMENDED SOLDER REFLOW METHOD



LOW TEMPERATURE INFRARED/CONVECTION	
$T_s$ MAX to $T_L$ (Ramp-up Rate)	5°C/Second Maximum
<b>Preheat</b>	
- Temperature Minimum ( $T_s$ MIN)	N/A
- Temperature Typical ( $T_s$ TYP)	150°C
- Temperature Maximum ( $T_s$ MAX)	N/A
- Time ( $t_s$ )	60 - 120 Seconds
Ramp-up Rate ( $T_L$ to $T_P$ )	5°C/Second Maximum
<b>Time Maintained Above:</b>	
- Temperature ( $T_L$ )	150°C
- Time ( $t_L$ )	200 Seconds Maximum
Peak Temperature ( $T_P$ )	240°C Maximum
Target Peak Temperature ( $T_P$ Target)	240°C Maximum 2 Times / 230°C Maximum 1 Time
Time within 5°C of actual peak ( $t_P$ )	10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time
Ramp-down Rate	5°C/Second Maximum
Time 25°C to Peak Temperature (t)	N/A
Moisture Sensitivity Level	Level 1
Additional Notes	Temperatures shown are applied to body of device.

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)



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